



CHENMKO ENTERPRISE CO., LTD

SURFACE MOUNT

Dual N-Channel Enhancement Mode Field Effect Transistor

VOLTAGE 20 Volts CURRENT 7 Ampere

CHM8208JGP

APPLICATION

- * Servo motor control.
- * Power MOSFET gate drivers.
- * Other switching applications.

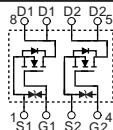
FEATURE

- * Small flat package. (SO-8)
- * High density cell design for extremely low $R_{DS(ON)}$.
- * Rugged and reliable.
- * High saturation current capability.

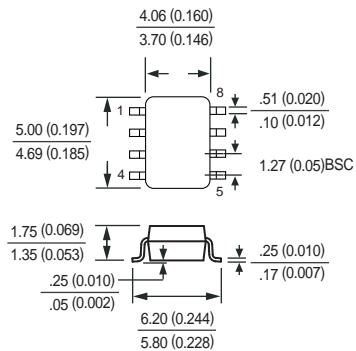
CONSTRUCTION

- * N-Channel Enhancement

CIRCUIT



SO-8



Dimensions in millimeters

SO-8

Absolute Maximum Ratings

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	CHM8208JGP	Units
V_{DSS}	Drain-Source Voltage	20	V
V_{GSS}	Gate-Source Voltage	± 12	V
I_D	Maximum Drain Current - Continuous	7	A
	- Pulsed (Note 3)	25	
P_D	Maximum Power Dissipation	2000	mW
T_J	Operating Temperature Range	-55 to 150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C

Note : 1. Surface Mounted on FR4 Board , $t \leq 10\text{sec}$
 2. Pulse Test , Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$
 3. Repetitive Rating , Pulse width limited by maximum junction temperature
 4. Guaranteed by design , not subject to production testing

Thermal characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1)	62.5	°C/W
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ELECTRICAL CHARACTERISTIC (CHM8208JGP)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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OFF CHARACTERISTICS

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V
$I_{\text{DS}(\text{SS})}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 20 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			1	μA
I_{GSSF}	Gate-Body Leakage	$V_{\text{GS}} = 12 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			+10	nA
I_{GSSR}	Gate-Body Leakage	$V_{\text{GS}} = -12 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			-10	nA

ON CHARACTERISTICS (Note 2)

$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	0.5		1.2	V
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = 4.5 \text{ V}, I_D = 7 \text{ A}$		18	22	$\text{m}\Omega$
		$V_{\text{GS}} = 2.5 \text{ V}, I_D = 5.6 \text{ A}$		24	32	

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$		40		pF
C_{oss}	Output Capacitance			115		
C_{rss}	Reverse Transfer Capacitance			15		

SWITCHING CHARACTERISTICS (Note 4)

Q_g	Total Gate Charge	$V_{\text{DS}} = 10 \text{ V}, I_D = 7 \text{ A}$ $V_{\text{GS}} = 4.5 \text{ V}$		4.2	5.6	nC
Q_{gs}	Gate-Source Charge			1.0		
Q_{gd}	Gate-Drain Charge			2.4		
t_{on}	Turn-On Time	$V_{\text{DD}} = 10 \text{ V}$ $I_D = 1 \text{ A}, V_{\text{GS}} = 4.5 \text{ V}$ $R_{\text{GEN}} = 6 \Omega$		0.34	0.68	uS
t_r	Rise Time			0.68	1.72	
t_{off}	Turn-Off Time			3.58	7.16	
t_f	Fall Time			2	4	

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I_s	Drain-Source Diode Forward Current	(Note 1)			7	A
V_{SD}	Drain-Source Diode Forward Voltage	$I_s = 7 \text{ A}, V_{\text{GS}} = 0 \text{ V}$	(Note 2)		1.2	V

RATING CHARACTERISTIC CURVES (CHM8208JGP)

Typical Electrical Characteristics

Figure 1. Output Characteristics

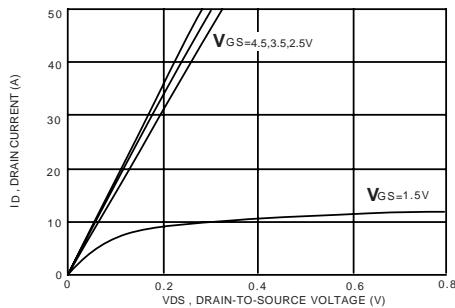


Figure 2. Transfer Characteristics

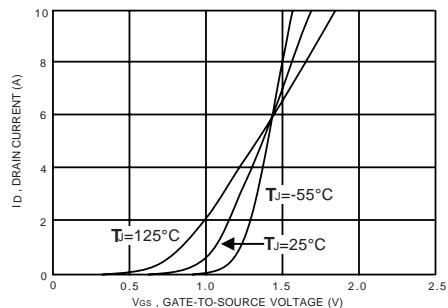


Figure 3. Gate Charge

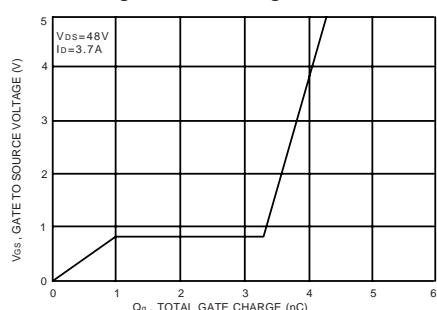


Figure 4. On-Resistance Variation with Temperature

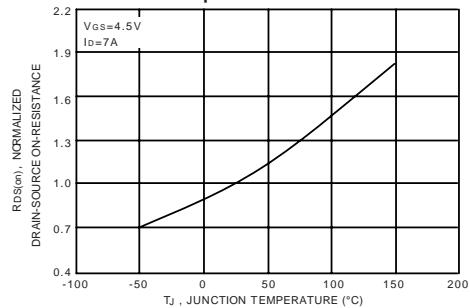


Figure 5. Gate Threshold Variation with Temperature

